

» Kontron User's Guide«



RTM8242

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Revision History

Rev. Index	Brief Description of Changes	Date of Issue
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Kontron reserves the right to make changes without notice in product or component design as warranted by evolution in user needs or progress in engineering or manufacturing technology. Changes that affect the operation of the unit will be documented in the next revision of this user's quide.

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Safety Instructions

Before You Begin

Before handling the board, read the instructions and safety guidelines on the following pages to prevent damage to the product and to ensure your own personal safety. Refer to the "Advisories" section in the Preface for advisory conventions used in this user's guide, including the distinction between Warnings, Cautions, Important Notes, and Notes.

- Always use caution when handling/operating the product. Only qualified, experienced, authorized electronics service personnel should access the interior of the product. The power supplies produce high voltages and energy hazards, which can cause bodily harm.
- Use extreme caution when installing or removing components. Refer to the installation instructions in this user's guide for precautions and procedures. If you have any questions, please contact Kontron Technical Support



WARNING



High voltages are present inside the chassis when the unit's power cord is plugged into an electrical outlet. Turn off system power, turn off the power supply, and then disconnect the power cord from its source before removing the chassis cover. Turning off the system power switch does not remove power to components.

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Preventing Electrostatic Discharge

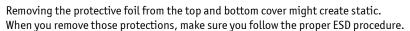
Static electricity can harm system boards. Perform service at an ESD workstation and follow proper ESD procedure to reduce the risk of damage to components. Kontron strongly encourages you to follow proper ESD procedure, which can include wrist straps and smocks, when servicing equipment.

Take the following steps to prevent damage from electrostatic discharge (ESD):

- When unpacking a static-sensitive component from its shipping carton, do not remove the component's antistatic packing material until you are ready to install the component in a computer. Just before unwrapping the antistatic packaging, be sure you are at an ESD workstation or grounded. This will discharge any static electricity that may have built up in your body.
- When transporting a sensitive component, first place it in an antistatic container or packaging.
- Handle all sensitive components at an ESD workstation. If possible, use antistatic floor pads and workbench pads.
- Handle components and boards with care. Don't touch the components or contacts on a board. Hold a board by its edges or by its metal mounting bracket.
- Do not handle or store system boards near strong electrostatic, electromagnetic, magnetic, or radioactive fields.
- When you want to remove the protective foil (if present), make sure you are properly grounded and that you touch a metallic part of the board.



CAUTION





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Preface

How to Use This Guide

This user's guide is designed to be used as step-by-step instructions for installation, and as a reference for operation, troubleshooting, and upgrades.

For the circuits, descriptions and tables indicated, Kontron assumes no responsibility as far as patents or other rights of third parties are concerned.

The following is a summary of chapter contents:

- Chapter 1, Product Description
- Chapter 2, Board Features
- Chapter 3, Hot Swap and Installation
- Appendix A, Connector Pinout
- Appendix B, Getting Help
- Appendix C, Glossary

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Customer Comments

If you have any difficulties using this user's guide, discover an error, or just want to provide some feedback, please send a message to: support@ca.kontron.com. Detail any errors you find. We will correct the errors or problems as soon as possible and post the revised user's quide on our Web site. Thank you.

Advisory Conventions

Seven types of advisories are used throughout the user guides to provide helpful information or to alert you to the potential for hardware damage or personal injury. They are Note, Signal Paths, Jumpers Settings, BIOS Settings, Software Usage, Cautions, and Warnings. The following is an example of each type of advisory. Use caution when servicing electrical components.



Note:

Indicate information that is important for you to know.



Signal Path:

Indicate the places where you can find the signal on the board.



Jumper Settings:

Indicate the jumpers that are related to this section.



Software Usage:

Indicates how you can access this feature through software.



CAUTION

Indicate potential damage to hardware and tells you how to avoid the problem.





WARNING

Indicates potential for bodily harm and tells you how to avoid the problem.





ESD Sensitive Device:

This symbol and title inform that electronic boards and their components are sensitive to static electricity. Therefore, care must be taken during all handling operations and inspections of this product, in order to ensure product integrity at all times.

Please read also the section "Special Handling and Unpacking Instructions".



CE Conformity:

This symbol indicates that the product described in this manual is in compliance with all applied CE standards. Please refer also to the section "Regulatory Compliance Statements" in this manual.

Disclaimer: We have tried to identify all situations that may pose a warning or a caution condition in this user's guide. However, Kontron does not claim to have covered all situations that might require the use of a Caution or a Warning.

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Unpacking

Follow these recommendations while unpacking:

- Remove all items from the box. If any items listed on the purchase order are missing, notify Kontron customer service immediately.
- Inspect the product for damage. If there is damage, notify Kontron customer service immediately.
- Save the box and packing material for possible future shipment.

Powering Up the System

Before any installation or setup, ensure that the board is unplugged from power sources or subsystems.

If you encounter a problem, verify the following items:

- Make sure that all connectors are properly connected.
- Verify your boot devices.
- If the system does not start properly, try booting without any other I/O peripherals attached, including AMC adapters.

Make sure your system provides the minimum DC voltages required at the board's slot, especially if DC power is carried by cables.

If you are still not able to get your board running, contact our Technical Support for assistance.

Storing Boards

Electronic boards are sensitive devices. Do not handle or store device near strong electrostatic, electromagnetic, magnetic or radioactive fields.

Regulatory Compliance Statements

FCC Compliance Statement for Class A Devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generated, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experience radio/TV technician for help.



WARNING



This is a Class A product. If not installed in a properly shielded enclosure and used in accordance with this User's Guide, this product may cause radio interference in which case users may need to take additional measures at their own expense.

Safety Certification

All Kontron equipment meets or exceeds safety requirements based on the IEC/EN/UL/CSA 60950-1 family of standards entitled, "Safety of information technology equipment." All components are chosen to reduce fire hazards and provide insulation and protection where necessary. Testing and reports when required are performed under the international IECEE CB Scheme. Please consult the "Kontron Safety Conformity Policy Guide" for more information. For Canada and USA input voltage must not exceed -60Vdc for safety compliance.

CE Certification

The product(s) described in this user's guide complies with all applicable European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques. Although Kontron offers accessories, the customer must ensure that these products are installed with proper shielding to maintain CE compliance. Kontron does not offer engineering services for designing cabling systems. In addition, Kontron will not retest or recertify systems or components that have been reconfigured by customers.

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Limited Warranty

Kontron grants the original purchaser of Kontron's products a TWO YEAR LIMITED HARDWARE WARRANTY as described in the following. However, no other warranties that may be granted or implied by anyone on behalf of Kontron are valid unless the consumer has the express written consent of Kontron.

Kontron warrants their own products, excluding software, to be free from manufacturing and material defects for a period of 24 consecutive months from the date of purchase. This warranty is not transferable nor extendible to cover any other users or long- term storage of the product. It does not cover products which have been modified, altered or repaired by any other party than Kontron or their authorized agents. Furthermore, any product which has been, or is suspected of being damaged as a result of negligence, improper use, incorrect handling, servicing or maintenance, or which has been damaged as a result of excessive current/voltage or temperature, or which has had its serial number(s), any other markings or parts thereof altered, defaced or removed will also be excluded from this warranty.

If the customer's eligibility for warranty has not been voided, in the event of any claim, he may return the product at the earliest possible convenience to the original place of purchase, together with a copy of the original document of purchase, a full description of the application the product is used on and a description of the defect. Pack the product in such a way as to ensure safe transportation (see our safety instructions).

Kontron provides for repair or replacement of any part, assembly or sub-assembly at their own discretion, or to refund the original cost of purchase, if appropriate. In the event of repair, refunding or replacement of any part, the ownership of the removed or replaced parts reverts to Kontron, and the remaining part of the original guarantee, or any new guarantee to cover the repaired or replaced items, will be transferred to cover the new or repaired items. Any extensions to the original guarantee are considered gestures of goodwill, and will be defined in the "Repair Report" issued by Kontron with the repaired or replaced item.

Kontron will not accept liability for any further claims resulting directly or indirectly from any warranty claim, other than the above specified repair, replacement or refunding. In particular, all claims for damage to any system or process in which the product was employed, or any loss incurred as a result of the product not functioning at any given time, are excluded. The extent of Kontron liability to the customer shall not exceed the original purchase price of the item for which the claim exists.

Kontron issues no warranty or representation, either explicit or implicit, with respect to its products reliability, fitness, quality, marketability or ability to fulfil any particular application or purpose. As a result, the products are sold "as is," and the responsibility to ensure their suitability for any given task remains that of the purchaser. In no event will Kontron be liable for direct, indirect or consequential damages resulting from the use of our hardware or software products, or documentation, even if Kontron were advised of the possibility of such claims prior to the purchase of the product or during any period since the date of its purchase.

Please remember that no Kontron employee, dealer or agent is authorized to make any modification or addition to the above specified terms, either verbally or in any other form, written or electronically transmitted, without the company's consent.

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Chapter 1

Product Description

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1. Product Description

1.1 Product Overview

The RTM8242 is an ATCA Rear Transition Module offering 84Gbps total uplinks with 4x 1GbE SFP and 8x 10GbE SFP+. It has been designed for the AT8242 ATCA Dual Octeon-II CN68XX Processor Blade.

RTM architecture includes:

- Support for 4x SFP 1GbE uplink;
 - 1000Base-SX/LX Optical Modules
 - 1000Base-T Copper Module
- Support for 8x SFP/SFP+ 10/1GbE uplink;
 - 10GBase-SR/LR Optical Modules
 - 1000Base-SX/LX Optical Modules
 - 1000Base-T Copper Module

1.2 What's Included

This board is shipped with the following items:

- One RTM8242 board
- One Quick Reference Sheet.
- One Documentation & Drivers disk

If any item is missing or damaged, contact the supplier.

1.3 Board Specifications

Table 1-1:Board Specifications

Features	Description
Compatible Products	• AT8242
Compliancy	 PICMG3.0 R3.0 PICMG HPM.1 PICMG3.1 R2.0
IPMI Features	 Management Controller compliant to PICMG 3.0, AMC.0 R2.0 and IPMI v2.0. Management Controller is run time field reprogrammable without payload impact. Robust fail safe reprogramming implementation (which includes two firmware images) that performs automatic or manual rollback if a problem occurs during critical reprogramming phase. Remote upgrade capability (via IPMB). Management Controller self test which can detect a failure in its code integrity and trigger an automatic rollback.
Supervisory	 Hardware system monitor through IPMI sensors (voltages and temperatures), alarms, events, power failure.
Mechanical	• 322.25 x 93.74 x 29 mm
Power Requirements	• 18W Typical; 25W Max.
Environmental Temperature*	 Operating: 0-55°C/32-131°F with 3.8CFM airflow Storage and Transit: -40 to +70°C/-40 to 158°F
Environmental Humidity*	 Operating: 15% to 90% @55°C/131°F non-condensing Storage and Transit: 5% to 95% @ 40°C/104°F non-condensing
Environmental Altitude*	 Operating: 4,000 m / 13,123 ft Storage and Transit: 15,000 m / 49,212 ft
Environmental Shock*	 Operating: 3G, half-sine 11ms, each axis Storage and Transit: 18G, half-sine 6ms, each axis
Environmental Vibration*	 Swept sine: 5-200Hz. 0.2G, each axis Operating random: 5Hz to 10Hz @ +12dB/oct (slope up) 10Hz to 50Hz @ 0.02m2/s3 (0.0002g2 /Hz) (flat) 50Hz to 100Hz @ -12dB/oct (slope down) Storage & transit: 5Hz to 20Hz @ 1m2/s3 (0.01g2 /Hz) (flat) 20Hz to 200Hz @ -3dB/oct (slope down)
Reliability	• MTBF: 784373 hours @ 40°C/104°F (Telcordia SR-332, issue 2)
Safety / EMC	 Safety: CE Mark to EN 60950-1:2001. Meets or exceeds UL 60950-1/CSA C22.2 No 60950-1-07 Designed to meet GR-1089-CORE EMI/EMC: FCC 47 CFR Part 15, Class A; CE Mark to EN55022/EN55024/EN300386
Warranty	Two years limited warranty

^{*} Designed to meet or exceed

1.4 Hot-Swap Capability

The RTM8242 supports Full Hot Swap capability as per PICMG3.0 R3.0. It can be removed from or installed in the system while it is on (without powering-down the system). Please refer to the PICMG3.0 R3.0 specification for additional details.

1.5 Interfacing with the Environment

1.5.1 RTM (rear transition module)

The RTM8242 is a single slot (6HP, 30.48mm) AdvancedTCA Rear Transition Module. This module provides additional connectivity for AT8242 front boards.

1.5.1.1 FRU Data EEPROM

• FRU Data EEPROM size is 128Kbit and it includes board identification and serial number information.

1.5.1.2 Hot Swap

As a Hot Swappable Intelligent Managed FRU, the RTM8242 (FRU2) includes a Management Controller, the AdvancedTCA Hot Swap indicator (Blue LED) and the standard AdvancedTCA handle switch.

1.5.1.2.1 Insertion and Removal of the Managed FRUs

After insertion, the front board detects and activates the management components of the FRU. When the handle is closed, the power budget and the e-keying negotiations start. Then, the front board's IPMC activates the payload components of the FRU.

Opening the bottom handle on the RTM will start the deactivation process of the RTM8242.

The operational state of the FRU is reported through the management subsystem's FRU Hot Swap sensors. The BLUE LED is 100% off when a FRU is operational and unsafe for extraction. An always on (100%) indicates that a FRU can safely be extracted; transitional states are identified through blinking patterns. Additional details on the standard FRU Hot Swap sensor and the BLUE LED usage can be found in the AdvancedTCA specifications.

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Chapter 2

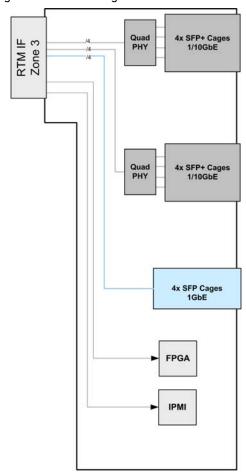
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2. Board Features

2.1 Block Diagram

Figure 2-1:Block Diagram



2.2 SFP

The RTM8242 has 4 SFP module connectors available on the RTM face plate. The SFP module signals come from the front board at 1Gb through Zone 3 connectors.

Table 2-1:Approved SFP Copper list

Manufacturer Part Number	Description	Company
ABCU-5710RZ	1000BASE-T Copper SFP Transceiver	Avago
FCLF-8521-3	1000BASE-T Copper SFP Transceiver	Finisar

Table 2-2:Approved SFP Optical list

Manufacturer Part Number	Description	Company
FTLF8519P2BNL	1.25 Gb/s 1000Base-SX Ethernet	Finisar
FTLX8571D3BCV	1G/10G Dual-Rate SFP+ transceivers	Finisar

2.3 SFP+

The RTM8242 has 8 SFP/SFP+ module connectors available on the RTM face plate. The SFP+ module signals come from the front board at 1/10Gb through Zone 3 connectors after passing through a signal conditioning PHY.

Table 2-3:Approved SFP+ list

Manufacturer Part Number	Description	Company
AFBR-703SDDZ	10Gb/1Gb Ethernet, 850nm SFP+ Transceiver	Avago
AFBR-703SDZ-IN2	10Gb Ethernet, 850nm SFP+ Transceiver	Intel
FTLX8571D3BCL	10Gb/s 850nm Multimode Datacom SFP+ Transceiver	Finisar
FTLX1471D3BCL	10Gb/s 1310nm Single Mode Datacom SFP+ Transceiver	Finisar

2.4 MMC Boot Block

The MMC runs Boot Block and IPMI firmware from its internal 512KB flash memory. The Boot Block firmware keeps the last two copies of the IPMI firmware in a dedicated external flash memory. The Boot Block activates the selected IPMI image and can rollback a firmware update in case of problems.

2.5 Hardware Management Overview

The RTM MMC communicates with the front board using the IPMB-L channel. Kontron's Intelligent RTM address on the IPMB-L is fixed and has a value of 0xA6.

The memory subsystem of the MMC consists of an integrated flash memory to hold the MMC operation code and integrated RAM for data. The field replacement unit (FRU) inventory information is stored in the nonvolatile memory on an EEPROM connected via a local I2C interface to the MMC. It is possible to store up to 4 KBytes within the FRU inventory information.

The onboard voltages and temperatures are monitored by the MMC. The MMC will send an event to the front board if any of the thresholds are exceeded. These and other events are sent over the IPMB-L bus to the front board's IPMC which forwards them to the SHMC. This ensures that 'post-mortem' logging information is available even if the power of the RTM is disabled.

To increase the reliability of the RTM8242 management subsystem, an external watchdog supervisor for the MMC is implemented. If the MMC ceases to service the watchdog supervisor, the watchdog resets the MMC. The external watchdog supervisor is not configurable and must not be confused with the IPMI watchdog timer commands.

2.5.1 Sensor Data Record (SDR)

Every sensor on the RTM is associated with a Sensor Data Record (SDR). Sensor Data Records contain information about the sensor's identification such as sensor type, sensor name and sensor unit. The SDR also contains the configuration of a specific sensor such as threshold/hysteresis and event generation capabilities that specify sensor behaviour. Some fields of the SDR are configurable through IPMI command and are set with built-in initial values. Finally, the sensor owner field must reflect the module addresses that allows a system management software to identify the owner of the SDR when it is scanned from the front board IPMC and merged within the IPMC Device SDR repository.

From an IPMI perspective, the RTM8242 management controller is set up as a satellite management controller (SMC). It supports sensor devices, and uses the IPMI static sensor population feature of IPMI to merge the hot swapped RTM sensor with the front board sensors population. The SHMC is informed about an RTM insertion through the RTM Module Hot Swap sensor and a radial presence line on the RTM connector. All SDRs can be queried using Device SDR commands. Module sensors that have been implemented are listed below.

2.5.2 Hardware Sensors

Table 2-4:IPMI Hardware Sensors

IPMI sensor ID	Sensor Name	Description (Sensor Type, Event trigger)	Scanning En- abled under Power State	Health LED (Green to Amber)
0	IPMI Info-1	Internal Management Controller firmware diagnostic	*	N
1	IPMI Info-2	Internal Management Controller firmware diagnostic	*	N
2	FRU Agent	FRU Information Agent - FRUO Data Error Detection	*	N
3	Module HS	Hot Swap state	*	N
4	IPMBL State	IPMB-L branch from FRU0 fault detection sensor	*	N
5	MMC Stor Err	Management sub-system health: non volatile memory error	*	N
6	MMC Reboot	IPMC reboot detection	*	N
7	IPMC VChange	IPMC Version Change Detection	*	N

IPMI sensor ID	Sensor Name	Description (Sensor Type, Event trigger)	Scanning En- abled under Power State	Health LED (Green to Amber)
8	FPGA VChange	FPGA Version Change Detection	*	N
9	Temp Air In	Inlet Temperature (degrees)	*	Χ
10	Temp Air Out	Outlet Temperature (degrees)	*	X
11	Temp Switch	Switch Temperature (degrees)	*	Χ
12	Temp MMC	Module Management Controller Temperature (Degrees)	*	X
13	Vcc +3.3VSUS	Voltage on board 3.3V suspend (management) power supply	*	Χ
14	Vcc +12V In	Voltage on board 12V payload power supply	-	X
15	Vcc +5V	Voltage on board 5V backend power supply	-	Χ
16	Vcc +3.3V	Voltage on board 3.3V backend power supply	-	X
17	Vcc +1.5V	Voltage on board 1.5V backend power supply	-	Χ
18	Vcc +1.2V	Voltage on board 1.2V backend power supply	-	X
19	Vcc +1V	Voltage on board 1.0V backend power supply	-	Χ
20	VPUMP	Voltage on board blue LED VPUMP suspend power supply	*	X
21	Power State	Board Power State	*	N
22	Power Good	Actual power good status	*	N
23	Health Error	General health status	*	N

- X Exceed critical threshold / Error Assertion
- * Power On/Off
- Power On
- N No change

2.5.2.1 IPMB-L Link Sensor

The RTM8242 has an IPMB-L link to communicate with the processor board and other devices in the chassis through IPMB-0 bus. MMC monitors the bus for any link failure and sends the bus failure event to the front board upon the recovery occurs.

2.5.3 Field Replaceable Unit (FRU) Information

The FRU Information provides inventory data about the boards where the FRU Information Device is located. The part number or version number can be read through software.

FRU information in the RTM8242 includes data describing the RTM8242 board according to AMC.0 R2.0 specification requirements. This information is retrieved from the RTM, enabling reporting of board-specific information through a standardized mechanism.

Table 2-5:Board Information Area

Board Information Area	
Field Description	Value (hex)
Format Version	0x01
Board Area Length	*Calculated
Language code	0x00
Manufacturing Date / Time	*Based on mfg. date
Board Manufacturer type/length	*Calculated
Board Manufacturer	"Kontron"
Board Product Name type/length	*Calculated
Board Product Name	"RTM8242"
Board Serial Number type/length	*Calculated
Board Serial Number	Manufacturer S/N
Board Part Number type/length	*Calculated
Board Customer Part Number	"T5709###_R"
FRU File ID type/length	*Calculated
FRU File ID	"FRU5709-YY"
No more fields	0xC1
Padding	0x00
Board Area Checksum	*Calculated

Table 2-6: Product Information Area

Product Information Area	
Field Description	Value (hex)
Format Version	0x01
Product Area Length	*Calculated
Language Code	0x00
Manufacturer Name type/length	*Calculated
Manufacturer Name	"Kontron"
Product Name type/length	*Calculated
Product Name	"RTM8242"
Product Part/Model Number type/length	*Calculated
Product Part/Model Number	"T5709_XX"*
Product Version type/length	*Calculated
Product Version	"XX" *
Product Serial Number type/length	*Calculated
Product Serial Number	Manufacturer S/N
Asset Tag type/length	0xC0
Asset Tag	
FRU File ID type/length	*Calculated

Product Information Area		
FRU File ID bytes	"FRU5709-YY"**	
No more fields	0xC1	
Padding	0x00	
Product Info Area Checksum	*Calculated	

Table 2-7:Type 16 Module Current Requirements Records

Type 16 – Module Current Requirements Record		
Record Type ID	COh	
Record format version	02h	
Manufacturer ID	00315Ah (PICMG Record ID)	
PICMG Record ID	16h (Module Power Descriptor table)	
Record Format Version	00h	
Current Draw	15h (2.1 Amps at 12 V => 25.2 Watts)	

2.5.4 MMC Firmware Code

MMC firmware code is organized into boot code and operational code, both of which are stored in internal flash memory. Upon an MMC reset, the MMC executes the boot code and performs the following:

- 1 Self test to verify the status of its hardware and memory.
- 2 Performs a checksum of the operational code.
- 3 Set operational state that tells the Boot Block that the firmware operates correctly.

Upon successful verification of the operational code checksum, the firmware will jump to the operational code.

2.5.5 MMC Firmware Upgrade Procedure

The upgrade procedure is compliant to PICMG HPM.1. MMC Firmware upgrades can be done by using IPMITOOL from <u>sourceforge</u> from the front board or remotely on the chassis. It has been designed to be upgradeable through any IPMI interface without payload impact.

2.5.6 Hot-Swap Process

The RTM8242 has the ability to be hot-swapped in and out of the front board. The onboard MMC manages the RTM's power-up and power-down transitions. The list below illustrates this process for power down request.

- 1 Ejector latch is opened. MMC firmware detects the event.
- 2 MMC sends "Module Handle Open" event message to the front board. The corresponding M state of the RTM moves from M4-> M5.

- 3 If the SHMC grants the request, the front board IPMC forwards the grant to the RTM. The RTM moves from M5->M6.
- 4 The firmware deasserts payload power and sends "Module Quiesced" event message to the front board and transitions from M6 to M1 state.

2.5.6.1 Hot-Swap LED

The RTM8242 supports a blue Hot Swap LED mounted on the front panel. This LED indicates when it is safe to remove the RTM from the front board. The on-board MMC drives this LED to indicate the hot-swap state. The following states are possible:

Table 2-8:Hot-Swap LED Description

LED state	Description
OFF	M4 state; normal state when board is in operation.
ON	M1 state; ready for hot swap.
Short blink	M5 state; deactivation request
Long blink	M2 state; activation request.

The SHMC or higher level software can reject the deactivation request. If this occurs, the RTM will return the Hot Swap LED to a solid off condition, indicating that the RTM has returned to M4 state.

When request is granted and main RTM payload power is successfully removed from the RTM slot, the Hot Swap LED is on continuously, indicating it is safe to remove the RTM from the chassis.

Refer to the AT8242 manual for information on "Managed FRU Deactivation Policies" affecting the FRU deactivation process.

2.6 Face Plate Indicators

The state of LED1 and LED2 can be controlled with standard PICMG LED APIs.

2.6.1 Hot Swap LED (LEDO)

The Blue / Hot Swap LED indicates the hot swap status of the RTM. The LED is ON when it is safe to remove the RTM from the slot. During normal operation, this LED is OFF.

2.6.2 Out Of Service (LED1)

The AdvancedTCA LED1 is red or amber and indicates an Out-of-Service (OOS) condition. During normal operation, the OOS LED is OFF. This LED is ON during firmware upgrade and is user configurable if needed by a customer application.

2.6.3 Healthy LED (LED2)

The AdvancedTCA LED2 is green or amber and indicates a Healthy condition. The healthy LED indicates if the blade is powered up and all voltages and temperatures are within specifications. During normal operation, this LED is ON (green). This LED is also ON (amber) when one of the RTM8242 voltage or temperature sensor pass a threshold.

2.6.4 SFP+ and SFP LED

The Green LEDs indicate the link status of the connection. The LED is ON when there is a link, otherwise it's OFF.

Chapter 3

Hot Swap and Installation

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3. Hot Swap and Installation

3.1 RTM Hot Swap and Installation

Because of the high-density pinout of the hard-metric connectors in Zone 3, some precautions must be taken when connecting or disconnecting a RTM to/from an AT8242:

- 1 Rail guides must be installed on the enclosure to slide the RTM to the AT8242.
- 2 Do not force the RTM if there is mechanical resistance while inserting it.
- 3 Screw the faceplate to the enclosure to firmly attach the RTM to its enclosure.
- 4 Use extractor handles to disconnect and extract the RTM from its enclosure.



WARNING

Always use a grounding wrist wrap before installing or removing the board from a chassis.



3.1.1 Installing the RTM in the chassis

To install the RTM:

- 1 Remove the filler panel from the slot.
- 2 Ensure the RTM is configured properly.
- 3 Carefully align the PCB edges at the bottom and top card quide.
- 4 Insert the RTM in the system until it makes contact with the front board.
- 5 Using both ejector handles, engage the RTM in the front board connectors until both ejectors are locked.
- 6 Fasten screws at the top and bottom of the faceplate.

3.1.2 Removing the RTM from the chassis

- 1 Unscrew the top and the bottom screw of the faceplate.
- 2 Unlock the lower handle latch.
- 3 Wait until the blue LED is fully ON, this means that the hot swap sequence is ready for RTM removal.
- 4 Use both ejectors to disengage the RTM from the front board.
- 5 Pull the RTM out of the chassis.

A. Connector Pinouts

A.1 Connectors and Headers Summary

Connector	Description
J1 - J8	SFP+ Connectors
J9 - J12	SFP Connectors
J31	RTM Connector
J32	RTM Connector

A.2 SFP+ Connectors (J1-J8)

Pin	Signal	Pin	Signal
1	VeeT	11	VeeR
2	TX_Fault	12	RD-
3	TX_Disable	13	RD+
4	SDA	14	VeeR
5	SCL	15	VccR
6	MOD-ABS	16	VccT
7	Rate_Select 0	17	VeeT
8	RX_LOS	18	TD+
9	Rate_Select 1	19	TD-
10	VeeR	20	VeeT

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A.3 SFP Connectors (J9-J12)

Pin	Signal	Pin	Signal
1	VeeT	11	VeeR
2	TX_Fault	12	RD-
3	TX_Disable	13	RD+
4	SDA	14	VeeR
5	SCL	15	VccR
6	MOD-ABS	16	VccT
7	Rate_Select 0	17	VeeT
8	RX_LOS	18	TD+
9	Rate_Select 1	19	TD-
10	VeeR	20	VeeT

A-2 RTM8242

B. Getting Help

If, at any time, you encounter difficulties with your application or with any of our products, or if you simply need quidance on system setups and capabilities, contact our Technical Support at:

North America EMEA

Tel.: (450) 437-5682 Tel.: +49 (0) 8341 803 333

Fax: (450) 437-8053 Fax: +49 (0) 8341 803 339

If you have any questions about Kontron, our products, or services, visit our Web site at: www.kontron.com

You also can contact us by E-mail at:

North America: support@ca.kontron.com

EMEA: support@kontron-modular.com

Or at the following address:

North America EMEA

Kontron Canada, Inc. Kontron Modular Computers GmbH

4555, Ambroise-Lafortune Sudetenstrasse 7

Boisbriand, Québec 87600 Kaufbeuren

J7H 0A4 Canada Germany

B.1 Returning Defective Merchandise

Before returning any merchandise please do one of the following:

- Call
- 1 Call our Technical Support department in North America at (450) 437-5682 and in EMEA at +49
 (0) 8341 803 333. Make sure you have the following on hand: our Invoice #, your Purchase
 Order #, and the Serial Number of the defective unit.
- 2 Provide the serial number found on the back of the unit and explain the nature of your problem to a service technician.

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- 3 The technician will instruct you on the return procedure if the problem cannot be solved over the telephone.
- 4 Make sure you receive an RMA # from our Technical Support before returning any merchandise.

• E-mail

1 Send us an e-mail at: RMA@ca.kontron.com in North America and at: orderprocessing@kontron-modular.com in EMEA. In the e-mail, you must include your name, your company name, your address, your city, your postal/zip code, your phone number, and your e-mail. You must also include the serial number of the defective product and a description of the problem.

B.2 When Returning a Unit

- In the box, you must include the name and telephone number of a contact person, in case further explanations are required. Where applicable, always include all duty papers and invoice(s) associated with the item(s) in question.
- Ensure that the unit is properly packed. Pack it in a rigid cardboard box.
- Clearly write or mark the RMA number on the outside of the package you are returning.
- Ship prepaid. We take care of insuring incoming units.

North America EMEA

Kontron Canada, Inc. Kontron Modular Computers GmbH

4555, Ambroise-Lafortune Sudetenstrasse 7

Boisbriand, Québec 87600 Kaufbeuren

J7H 0A4 Canada Germany

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C. Glossary

ACPI AdvancedMC (Same as AMO, Advanced Mezzanine Card. AMC (Same as AMO, Advanced Mezzanine Card. AMC (Same as AMO, Advanced Mezzanine Card. AMC.0 Advanced Mezzanine Card Base Specification. AMC.1 PCI Express and Advanced Switching on AdvancedMC. A subsidiary specification to the Advanced Mezzanine Card Base Specification (AMC.0). AMC.2 Ethernet Advanced Mezzanine Card Base Specification (AMC.0). AMC.3 Advanced Mezzanine Card Base Specification (AMC.0). AMC.3 Advanced Mezzanine Card Specification (AMC.0). AMC.3 Advanced Mezzanine Card Specification (AMC.0). ACCA Advanced Mezzanine Card Specification Computing Architecture BIOS Basic Input/Output System CMOS General Processing Unit. This sometimes refers to the small amount of battery (or capacitor) powered CMOS memory to hold the date, time, and system setup parameters. CPU Central Processing Unit. This sometimes refers to a whole blade, not just a processor component. CIS Clear To Send DIR Basic Input/Output System Director Specification Commission FRU Basic Replaceable Unit. Any entity that can be replaced by a user in the field. Not all FRUs are hot swappable. AND GrouND HDD Hard disk Drive HPM PICMG Hardware Platform Management Specification family HPM.1 Hardware Platform Management IPM Controller Firmware Upgrade Specification IEEE Institute of Electrical and Electronics Engineers IPM Intelligent Platform Management Bus Channel O, the logical aggregation of IPMB-A and IPMB-B. Intelligent Platfor	Acronyms	Descriptions
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IEEE Institute of Electrical and Electronics Engineers IPM Intelligent Platform Management IPMB Intelligent Platform Management Bus IPMB-0 Intelligent Platform Management Bus Channel O, the logical aggregation of IPMB-A and IPMB-B. IPMB-A Intelligent Platform Management Bus A IPMB-B Intelligent Platform Management Bus B IPMB-L Intelligent Platform Management Bus Local IPMC Intelligent Platform Management Controller IPMI Intelligent Platform Management Interface IPMIFWU Intelligent Platform Management Interface FirmWare Update LED Light-Emitting Diode MMC Module Management Controller. MMCs are linked to the IPMC. NC Not Connected	I2C	Inter Integrated Circuit bus
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IPMB-L Intelligent Platform Management Bus Local IPMC Intelligent Platform Management Controller IPMI Intelligent Platform Management Interface IPMIFWU Intelligent Platform Management Interface FirmWare Update LED Light-Emitting Diode MMC Module Management Controller. MMCs are linked to the IPMC. NC Not Connected	IPMB-A	Intelligent Platform Management Bus A
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IPMIFWU Intelligent Platform Management Interface FirmWare Update LED Light-Emitting Diode MMC Module Management Controller. MMCs are linked to the IPMC. NC Not Connected	IPMC	Intelligent Platform Management Controller
LED Light-Emitting Diode MMC Module Management Controller. MMCs are linked to the IPMC. NC Not Connected	IPMI	Intelligent Platform Management Interface
MMC Module Management Controller. MMCs are linked to the IPMC. NC Not Connected	IPMIFWU	Intelligent Platform Management Interface FirmWare Update
NC Not Connected	LED	Light-Emitting Diode
	MMC	Module Management Controller. MMCs are linked to the IPMC.
00S Out 0f Service	NC	Not Connected
	00S	Out Of Service

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Acronyms	Descriptions
OS	Operating System
PICMG	PCI Industrial Computer Manufacturers Group
PICMG®	PCI Industrial Computer Manufacturers Group
POST	Power-On Self-Test
RAM	Random Access Memory
RS-232	(Same as RS232). Recommended Standard 232.
RS232	(Same as RS-232). Recommended Standard 232.
RTM	Rear Transition Module
RTS	Request To Send
SAS	Serial Attached SCSI
SFP, SFP+	Small Form-factor Pluggable
SHMC	Shelf Management Controller
TX	Transmit
TXD	Transmit
USB	Universal Serial Bus
VCC	Power supply

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